



MYD-YT507H Development Board Overview



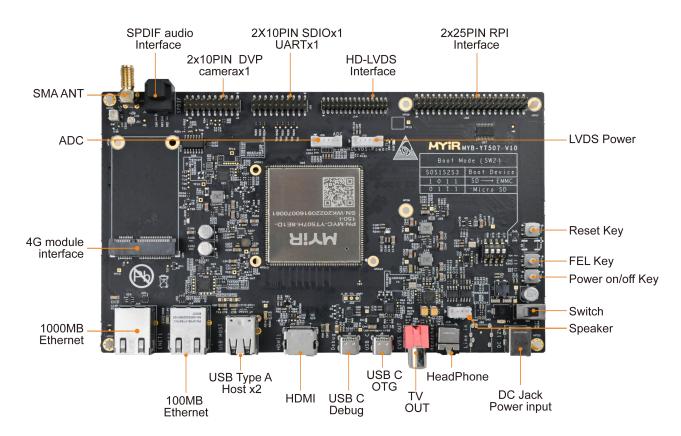
- ✓ MYC-YT507H CPU Module as Controller Board
- ✓ 1.5GHz ALLWINNER T507-H Quad-core ARM Cortex-A53 Automotive Grade Processor
- ✓ 1GB/2GB LPDDR4, 8GB eMMC Flash, 32Kbit EEPROM
- ✓ Serial ports, 1 x Gigabit Ethernet, 1 x 10/100M bps Ethernet, 2 x USB 2.0 Host, 1 x USB 2.0 OTG, TF Card Slot
- ✓ Supports Dual LVDS, HDMI and CVBS Display Output Interfaces to Achieve Different Display in Dual Screens
- ✓ Supports MIPI-CSI and DVP Camera Input
- ✓ Supports Running Linux / Android OS
- ✓ Optional LCD Modules, Camera Modules, WiFi/BT Module and RPI Module (RS232/RS485)

The <u>MYD-YT507H Development Board</u> consists of a compact CPU Module <u>MYC-YT507H</u> and a base board to provide a complete evaluation platform for ALLWINNER T507-H Processor which among <u>Allwinner T5</u> series with a 1.5GHz quad-core Cortex-A53 CPU and a Mali-G31 MP2 GPU. The processor is AEC-Q100 certified and targets the new generation of automotive markets. Typical applications are power IoT, automotive electronics, commercial display, industrial control, medical devices, intelligent terminals and more others.

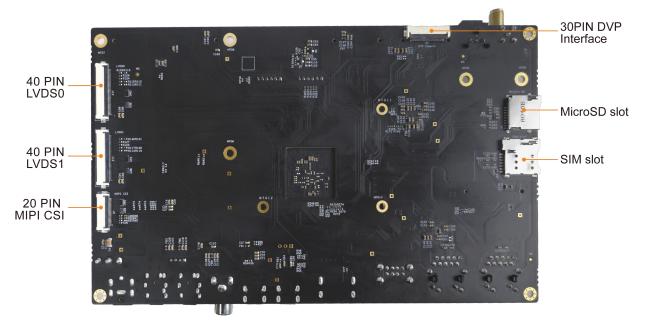
The MYD-YT507H has a base board which installed <u>MYC-YT507H CPU Module</u> through 1.0mm pitch 164-pin Castellated-Hole and 50-pin LGA expansion interfaces. The MYC-YT507H CPU Module is a highly-integrated SoM which combines the ALLWINNER T507-H processor, 1GB/2GB DDR4, 8GB eMMC, 32Kbit EEPROM and PMIC. The base board is explored with Serial ports, one Gigabit Ethernet and one 10/100M bps Ethernet, two USB 2.0 HOST and one USB 2.0 OTG, one TF card slot as well as a USB based 4G Mini PCIE interface. It has a DVP camera interface and a MIPI-CSI interface to allow connecting with camera modules. It also supports multi video output interfaces such as dual LVDS, HDMI and CVBS OUT, to achieve different display in dual screens.

The <u>MYD-YT507H Development Board</u> is delivered with one Quick Start Guide, one USB cable, one 12V/2A power adapter and one DC power jack adapter to provide user a complete platform for evaluating and prototyping based on T507H processor. MYIR also offers <u>MY-CAM002U USB Camera Module</u>, <u>MY-CAM011B DVP Camera</u> Module, <u>MY-CAM003M MIPI Camera Module</u>, <u>MY-WIREDCOM RPI Module</u> (RS232/RS485), <u>MY-WF005S WiFi/BT</u> <u>Module</u> and <u>MY-LVDS070C LCD Module</u> as options for the board which have greatly enhanced the functionality of the board.

The MYD-YT507H is capable of running Linux or Android OS. MYIR provides abundant software resources for Linux 4.9 based MYIR MEasy HMI V2.0 system with QT5.12.5, Ubuntu 18.04.5 system and Android10 system, including kernel, driver source codes and compilation tools to enable users to start their development rapidly and easily.



MYD-YT507H Development Board Top-view



MYD-YT507H Development Board Bottom-view

Hardware Specification

The MYC-YT507H CPU Module populated on the MYD-YT507H Development Board is using Allwinner T507-H Microprocessor with 15 mm x 15 mm size,0.65 mm ball pitch,0.35 mm ball size, TFBGA 421balls. The chip family integrates Cortex-A53 quad-core CPU, G31 MP2 GPU, 32-bit DDR3/LPDDR3/DDR4/LPDDR4 DRAM, multi video output interfaces (RGB/2*LVDS/ HDMI/CVBS OUT), and multi video input interfaces(MIPI CSI/BT656/BT1120). The chip family supports 4K@60fps H.265 decoder, 4K@25fps H.264 encoder, DI, 3D noise reduction, SmartColor system, and keystone correction module, which provides smooth user experience and professional visual effect. Supports 4 x USB, 2 x Ethernet MAC, 6 x UART, 6 x TWI, 4 x GPADC, greatly facilitating product expansion.

Image In	C	Connectivity	
Parallel CSI 16-bit bus	Ouad-core Cortex™- A53 @1.5GHz		USB2.0 OTG
4-lane MIPI CSI	Quad core conte	Quad-core Cortex A53 @1.56HZ	
Display Out	GPU	System Peripheral	UART x6
Display Engine Dual display	G31 MP2	сси	SPLx2
4 UI + 2 Vedio 4K@30fps		GIC	
HDMI 2.0a	Video Engine	Thermal Sensor	TWI x6
4K@60fps	H.265 4K@60fps	Timer	TSC
RGB/LVDS/BT656 1080p@60fps	Video Decoder	High Speed Timer	SCR
CVBSOUT	H.264 4K@25fps Video Encoder	PSI	
CVBSOOT		DMA	CIR Receiver
Audio	External Memory	IOMMU	GPADC(4-ch)
Audio Codec	DDR4/LPDDR4/ DDR3 /DDR3L 32-bit bus	Security System	LRADC(1-ch)
DMIC	8-bit Nand Flash	Security Boot	PWM(6-ch)
OWA OUT	80-bit ECC	Crypto Engine	SDIO 3.0
Audio HUB	SD3.0/eMMC5.0	SID(2Kbits)	
(I2S/PCM x 3)	1/4/8-bit bus	TrustZone	Ethernet MACx2

ALLWINNER T507-H Processor Block Diagram



Resources	Parametric Description
CPU	● Quad-core ARM Cortex TM -A53@1.5Ghz
	• G31 MP2
GPU	• Supports OpenGL ES 3.2/2.0/1.0, Vulkan 1.1, OpenCL 2.0
	• 32-bit DDR4/DDR3/DDR3L/LPDDR3/LPDDR4 interface, supporting maximum capacity of 4GB
External Storage	• SD3.0/eMMC5.0 interface
0	• 8-bit Nand flash interface with maximum 80-bit/1KB ECC
	Video decoder
	• H.265 MP decoder up to 4K@60fps, H.264 BL/MP/HP decoder up to 4K@30fps
	• VP9 decoder up to 4K@60fps, AVS2 decoder up to 4K@60fps
	 Multi-format 1080p@60fps video playback, including VP8, MPEG1/2 SP/MP, MPEG4 SP/ASP,
Video Engine	• AVS+/AVS JIZHUN, VC1 SP/MP
the mane	Video encoder
	 H.264 encoder up to 4K@25fps
	 MJPEG encoder up to 4K@15fps
	 JPEG encoder up to 8K x 8K resolution
	 Supports one 8-/10-/12-/16-bit digital camera(DC) interface
	 Maximum pixel clock of 148.5MHz for each DC interface
	 BT656, BT1120 video input for multichannel YUV
Video Input	 Four-lane MIPI CSI, up to lGbps per lane in HS transmission, compliant with MIPI-CSI2 V1.00
video input	 and MIPI DPHY V1.00
	 Maximum video capture resolution of 8M@30fps or 4x 1080p@25fps for MIPI CSI
	 Maximum video capture resolution of om@30ps of 4x 1000p@23ps for Mill CSI Supports formats: YUV422, YUV420, RAW-8, RAW-10, RAW-12
	Supports formats. 100422, 100420, KAW-0, KAW-10, KAW-12 Two DAC channels
	 Supports 1 audio output interface (differential LINEOUTP/N or single-end LINEOUTL/LINEOUTR)
	One Audio HUB, supporting internal mixing function Embedded 2 125 (DCM for connecting the automal devices
	• Embedded 3 I2S/PCM for connecting the external devices
Audio	(I2S0 for extended audio codec, I2S2 for BT, I2S3 for digital power amplifier)
	 Supports Left-justified, Right-justified, Standard I2S mode, PCM mode, and TDM mode I2S much supports 0, shown the and 22 bit (102) bit sounds such as the support of the suppo
	 I2S mode supports 8 channels, and 32-bit/192kbit sample rate I2S and TDM and be support and investigation of a 22 bit/061bit sample rate
	• I2S and TDM-modes support maximum 16 channels, and 32-bit/96kbit sample rate
	 One OWA OUT interface, supporting 16-/20-/24-bit outputs Interpreted distributions and a distribution of the support of the suppor
	Integrated digital microphone, supporting maximum 8 digital PDM microphones
	• HDMI 2.0a up to 4K@60fps
Display Output	• TV CVBS output, supporting PAL/NTSC
	 LVDS interface with dual link, up to 1080p@60fps DCD is to for a site DE (GVDC and the second s
	RGB interface with DE/SYNC mode, up to 1080p@60fps
	• Supports Full Disk Encryption
	• AES, DES, 3DES, and XTS encryption and decryption algorithms
	• MD5, SHA, and HMAC tamper proofing
Security Engine	• RSA, ECC signature and verification algorithms
	• Supports 160-bit hardware pseudo random number generator(PRNG) with 175-bit seed
	• Supports 256-bit hardware true random number generator(TRNG)
	Integrated 2K-bit EFUSE for chip ID and security application
	• 3 x USB2.0 Host, 1 x USB2.0 OTG
Interfaces	• 2 x Ethernet MAC (one 10/100 Mbps Ethernet port, one 10/100/1000 Mbps Ethernet port)
	• SDIO 3.0, TSC, SCR, CIR Receiver
	• 6 x TWI, 2 x SPI, 6 x UART, 6-ch PWM, 4-ch GPADC. 1-ch LRADC
PMIC	Companion Allwinner Power Management IC
Packaging	• TFBGA 421balls
	• 15 mm x 15 mm size, 0.65 mm ball pitch, 0.35 mm ball size
Process Technology	• 28nm HPC

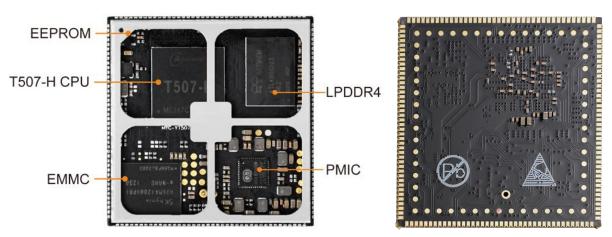
Features of T507-H Processor

The MYD-YT507H Development Board is using MYC-YT507H CPU Module as core controller board. It takes full features of T507-H processor and the main features are characterized as below:

Mechanical Parameters

- Dimensions: 200mm x 120mm (base board), 43mm x 45mm (CPU Module)
- PCB Layers: 6-layer design (base board), 10-layer design (CPU Module)
- Power supply: +12V/2A (base board), 5V/2A (CPU Module)
- Working temperature: -40~85 Celsius (industrial grade)

The MYD-YT507H Controller Board (MYC-YT507H CPU Module)



MYC-YT507H CPU Module Top-view and Bottom-view (delivered with shielding cover installed by default)

Processor

- Allwinner T507H processor
 - Up to 1.5GHz Quad-core ARM Cortex-A53
 - ARM Mali-G31 MP2 GPU with support for OpenGL ES 3.2/2.0/1.0, Vulkan 1.1, OpenCL 2.0

Memory

- 1G/2G LPDDR4 (supports optional 3GB / 4GB LPDDR4)
- 8GB eMMC (supports optional 4GB, 16GB / 64GB eMMC)
- 32Kbit EEPROM

Peripherals and Signals Routed to Pins

- Power Management IC (Allwinner AXP853T)
- 1.0mm pitch 164-pin Castellated-Hole and 58-pin LGA expansion interfaces
 - up to 138 x GPIO
 - 1 x RGMII and 1 x RMII
 - 4 x I2C and 2 x SPI
 - 3 x USB 2.0 Host and 1 x USB 2.0 OTG
 - 1 x DVP digital camera and 1 x MIPI CSI camera
 - 2 x SDIO
 - 6 x UART
 - 4 x GPADC and 1x LRADC
 - 1 x HDMI 2.0a (supports 4K@60fps)
 - 2 x Single-channel LVDS or 1 x Dual-channel LVDS or 24-bit RGB (supports up to 1080p@60fps)
 - 1x TV CVBS output (supports PAL/NTSC)
 - 1 x JTAG

- 3x I2S/PCM

- 1x Audio out

Note: the peripheral signals brought out to the expansion interface are listed in maximum number. Some signals are reused. Please refer to the processor datasheet and the CPU Module pinout description file.

The MYD-YT507H Development Board Base Board

- 1 x Power Jack
- 1 x Power Switch
- Serial ports
 - 1 x Debug UART (TTL, USB Type-C connector)
 - 2 x TTL serial ports (UART2, UART5)
- USB
 - 2 x USB2.0 Host port
 - 1 x USB 2.0 OTG port (Type-C)
 - 1 x Mini-PCIe interface (for 4G LTE Module)
- 1 x SIM card slot
- Ethernet
 - 1 x 10/100/1000 Mbps Ethernet interface (RJ45, ENET1)
 - 1 x 10/100 Mpbs Ethernet interface (RJ45, ENET2)
- 1 x Micro SD card slot
- Video Input
 - 1 x MIPI-CSI Interface (0.5mm pitch 24-pin FPC connector) Supports MYIR's <u>MY-CAM003M Camera Module</u> through J2
 - 1 x DPV Camera Interface (0.5mm pitch 30-pin FPC connector)

Supports MYIR's MY-CAM011B Camera Module through J3

- Video Output
 - 1 x HDMI Output Interface
 - 2 x Single-channel LVDS Display interface (LVDS0 & LVDS1, 40-pin 0.5mm pitch FPC connector)
 - 1 x Dual-channel LVDS Display interface (J14, 30-pin 2.0mm pitch header connector)

Supports MYIR's <u>MY-LVDS070C LCD Module</u> with Capacitive Touch Screen through the LCD interface - 1 x TV CVBS Display interface

- Audio
 - 1 x 3.5mm Headphone/Mic Jack
 - 1 x SPDIF Audio Output
 - 1 x Speaker
- 1 x 2.54mm 2 x 20-pin male expansion header (J25, GPIO/TWI/UART, compatible with Raspberry PI standard 40-pin extension interface)

Supports MYIR's MY-WIREDCOM RPI Module through J25 to extend RS485 and RS232 functions

- 1 x 2.54mm 2*10-pin male expansion header (J26)
 - 1 x SDIO
 - 1 x UART

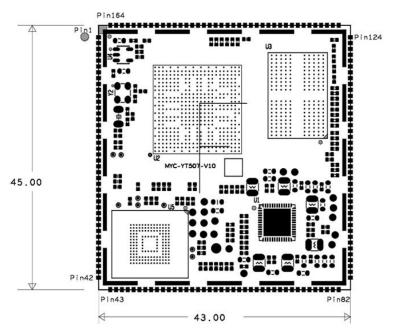
Supports MYIR's <u>MY-WF005S WiFi/BT Module</u> through the J26

- 3 x Buttons (one for Reset, one for Power On/Off and one for FLASH)
- 1 x RTC Battery Interface

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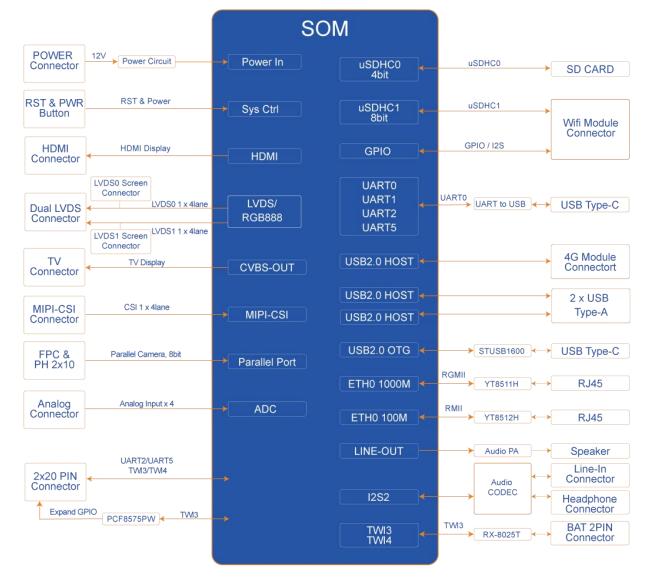
		T507H					
PMIC1		→ S-TWI3	UART0 UART1 UART2 UART5			4 x UART	
E2PROM 256KB			USB2.0 OTG		>	1 x USB2.0	
			USB2.0 HOST 🗲		>		
LPDDR4 4GB,x32		LPDDR4 1ch, x32/ch	USB2.0 HOST 4	16	>	3 x USB2.0	
			USB2.0 HOST *		>		
eMMC		uSDHC2 8bit	ETH0 1000M 🔸		-	1 x RGMII	
8GB			ETH1 100M <		>	1 x RMII	
			uSDHC0 4bit		>	uSDHC0 4bit	(I)
Crystal	24MHz	→	uSDHC1 8bit		>	uSDHC1 8bit	P
Crystal	32KHz	→	TWI1 TWI3 TWI4		-	3 x TWI	Stamp Hole
			HDMI -		>	1x HDMI	Sta
			LVDS0 -	LVDS 1 x 4lane	,	2x LVDS/	
			LVDS1	LVDS 1 x 4lane	-	1 x RGB888	
			CVBS-OUT		>	1x CVBS-OUT	
			MIPI-CSI	MIPI-CSI 1 x 4lane		1x MIPI-CSI	
			Parallel Port	-		1x Parallel Camera	
			12S2 12S3		->	2 x 12S	
			LINE-OUT		>	1 x LINE-OUT	
			PWM –		>	4 xPWM	
	4		ADC 🔸	12bit resolution ,4ch		4 x Input	
SOM	1		GPIO +		>	GPIO	

MYC-YT507H CPU Module Function Block Diagram

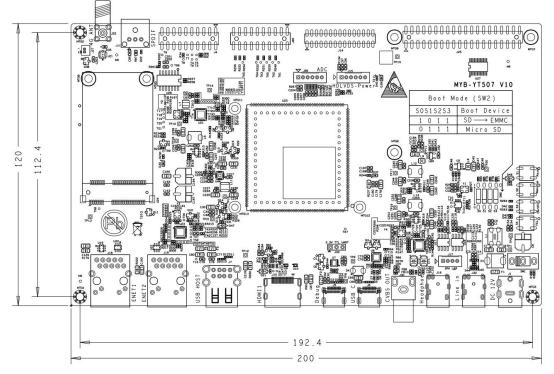


MYC-YT507H Dimensions Chart (Unit: MM)

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MYD-YT507H Development Board Function Block Diagram



MYD-YT507H Base Board Dimensions Chart (Unit: MM)

Software Features

The MYC-YT507H CPU module supports Linux and Android OS, which comes with software packages. The kernel and many peripheral drivers are available in source code to assist clients expedite their ideas. The following are a summary of the software features:

Item	Feature	Description	Source Code
Bootloader	U-boot	Boot boot program uboot_2018	YES
Linux kernel	Linux kernel	Customized base on official kernel_4.9.17 version	YES
	РМІС	AXP858 driver	YES
	USB Host	USB Host driver	YES
	USB OTG	USB OTG driver	YES
	TWI	TWI bus driver	YES
	SPI	SPI bus driver	YES
	Ethernet	10M/100M/1000M driver	YES
	SDC	eMMC/TF card storage driver	YES
	HDMI	HDMI display driver	YES
	Singer LVDS	7-inch single-channel LVDS driver	YES
	Double LVDS	21.5 inch dual LVDS driver	YES
	CVBS OUT	CVBS display driver	YES
	Linout	audio output driver	YES
	SPDIF	SPDIF audio output driver	YES
Device driver	audio	Sgtl5000 audio driver	YES
	4G	4G driver	YES
	PWM	PWM control	YES
	GPADC	GPADC driver	YES
	LRADC	LRADC driver	YES
	RTC	real time clock driver	YES
	IO driver	Generic GPIO driver	YES
	tty	RS232/RS485/TTL driver	YES
	Touch	capacitive touch	YES
	Camera (DVP)	500W camera driver	YES
	Camera (MIPI)	500W camera driver	YES
	WiFi & BT	AP6212 driver	YES
	Watchdog	Watchdog driver	YES
	Ubuntu18.04	Base on ubuntu-base-18.04.5-base-arm64	YES
File system	myir-image-full	Base on buildroot construction zone Qt 5.12.5 file system	YES
	myir-image-android10	Compiled and constructed based on Android10 SDK	YES

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	GPIO LED	Indicator routine	YES
	GPIO KEY	keystroke routine	YES
	NET	TCP/IP Sokect C/S routine	YES
	eeprom	Read/write eeprom routine	YES
Application	RTC	Real Time Clock routine	YES
Program	RS232	RS232 routine	YES
	RS485	RS485 routine	YES
	LCD	LCD routine	YES
	Camera	Camera display routine	YES
Compiler Tool Chain	Cross compiler	gcc-linaro-7.4.1-2019.02-x86_64_aarch64-linux-gnu	BINARY

MYD-YT507H Software Features

Order Information

Product Item	Part No.	Packing List
MYD-YT507H Development Board	MYD-YT507H-8E1D-150-I	 ✓ One MYD-YT507H Development Board (including MYC-YT507H CPU Module) ✓ One USB TYPE-A to TYPE-C cable
	MYD-YT507H-8E2D-150-I	 ✓ One 12V/2A Power adapter ✓ One DC Power jack adapter ✓ One Quick Start Guide
MYC-YT507H CPU Module	MYC-YT507H-8E1D-150-I	Add-on Options
	MYC-YT507H-8E2D-150-I	✓ MYC-YT507H CPU Module
MY-CAM002U USB Digital Camera Module	MY-CAM002U	 ✓ MYC-YISO/H CPO Module ✓ MY-CAM002U USB Digital Camera Modu ✓ MY-CAM011B BUS Camera Module
MY-CAM011B BUS Camera Module MY-CAM003M MIPI Camera Module	MY-CAM011B	 ✓ MY-CAM011D D05 Camera Module ✓ MY-CAM003M MIPI Camera Module ✓ MY-LVDS070C 7-inch LCD Module
	МҮ-САМ003М	 ✓ MY-WIREDCOM RPI Module ✓ MY-WF005S WiFi/BT Module
MY-LVDS070C 7 inch LCD Module	MY-LVDS070C	
MY-WIREDCOM RPI Module (RS485/RS232)	MY-WIREDCOM	
MY-WF005S WiFi/BT Module	MY-WF005S	



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